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# N-Channel 200 V (D-S) 175 °C MOSFET



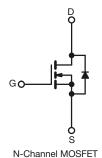
PRODUCT SUMMARY		
V <sub>DS</sub> (V)	200	
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0375	
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 7.5 \text{ V}$	0.0422	
Q <sub>g</sub> typ. (nC)	21	
I <sub>D</sub> (A)	35.1	
Configuration	Single	

#### **FEATURES**

- ThunderFET® power MOSFET
- Low R<sub>DS</sub> Q<sub>g</sub> figure-of-merit (FOM)
- Maximum 175 °C junction temperature
- 100 % R<sub>a</sub> and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

## **APPLICATIONS**

- · Synchronous rectification
- Power supplies
- DC/AC inverter
- DC/DC converter
- · Solar micro inverter
- Motor drive switch



COMPLIANT

HALOGEN

**FREE** 

ORDERING INFORMATION	
Package	TO-263
Lead (Pb)-free and halogen-free	SUM90330E-GE3

<b>ABSOLUTE MAXIMUM RATI</b>	<b>NGS</b> (Τ <sub>A</sub> = 25 °C, ι	ınless otherv	vise noted)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	200	
Gate-source voltage		V <sub>GS</sub>	± 20	V
Cartinua durin aument	T <sub>C</sub> = 25 °C		35.1	
Continuous drain current	T <sub>C</sub> = 125 °C	l <sub>D</sub>	20.3	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	70	А
Continuous source-drain diode current		I <sub>S</sub>	12.5	
Single pulse avalanche current <sup>a</sup>	. 0411	I <sub>AS</sub>	33	
Single pulse avalanche energy a	L = 0.1 mH	E <sub>AS</sub>	54.45	mJ
Marrian and a sure discipation	T <sub>C</sub> = 25 °C	Б	125 <sup>b</sup>	10/
Maximum power dissipation	T <sub>C</sub> = 125 °C	P <sub>D</sub>	41.7 <sup>b</sup>	W
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C
Soldering recommendations (peak temp	perature) <sup>c</sup>		260	

THERMAL RESISTANCE RATING	is			
PARAMETER		SYMBOL	MAXIMUM	UNIT
Maximum junction-to-ambient (PCB mount) c		R <sub>thJA</sub>	40	°C/W
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	1.2	C/VV

#### Notes

- a. Duty cycle ≤ 1 %
- b. See SOA curve for voltage derating
- c. When mounted on 1" square PCB (FR4 material)



www

## **SUM90330E**

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<b>SPECIFICATIONS</b> ( $T_J = 25  ^{\circ}\text{C}$ , UPARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	OTHIDOL	1201 GONDINONG	1411141		IVI/-DX.	Oiiii
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	200	_	_	V
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	_	4	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	_	250	nA
	1000	$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}$	_	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	_	-	150	μA
3	500	V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C	-	-	5	mA
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	20	-	-	Α
	, ,	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12.2 A	-	0.0312	0.0375	_
Drain-source on-state resistance a	R <sub>DS(on)</sub>	V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 11.5 A	-	0.0337	0.0422	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A	-	28	-	S
Dynamic <sup>b</sup>		-			L	
Input capacitance	C <sub>iss</sub>		-	1172	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	150	-	рF
Reverse transfer capacitance	C <sub>rss</sub>		-	11	-	
Total gate charge	Qg		-	21	32	
Gate-source charge	$Q_{gs}$	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 12.2 \text{ A}$	-	6	-	nC
Gate-drain charge	Q <sub>gd</sub>		-	5.3	-	
Gate resistance	$R_g$	f = 1 MHz	0.76	3.8	7.6	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	12	24	
Rise time	t <sub>r</sub>	$V_{DD} = 100 \text{ V}, R_L = 14.2 \Omega, I_D \cong 7 \text{ A},$	-	25	50	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	30	50	ns
Fall time	t <sub>f</sub>		-	22	44	
Drain-Source Body Diode Characteristi	cs					
Pulse diode forward current (t = 100 μs)	I <sub>SM</sub>		-	-	70	Α
Body diode voltage	V <sub>SD</sub>	I <sub>F</sub> = 7 A, V <sub>GS</sub> = 0 V	-	0.8	1.5	V
Body diode reverse recovery time	t <sub>rr</sub>		-	111	170	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 7 A, di/dt = 100 A/μs	-	0.51	1	μC
Reverse recovery fall time	t <sub>a</sub>	i <sub>F</sub> = 7 A, αί/αι = 100 A/μS	-	94	-	no
Reverse recovery rise time	t <sub>b</sub>		-	17	-	ns
Body diode peak reverse recovery charge	I <sub>RM(REC)</sub>		-	8.5	17	Α

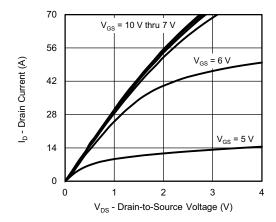
## Notes

- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

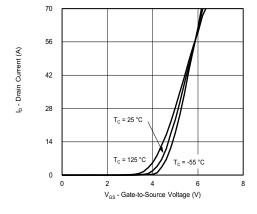
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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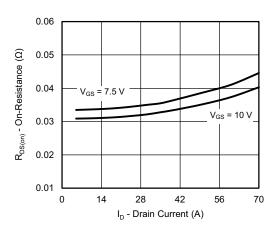
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



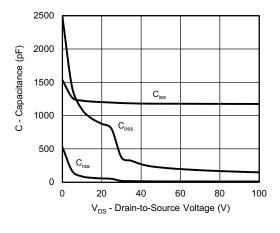
**Output Characteristics** 



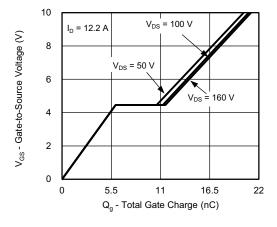
**Transfer Characteristics** 



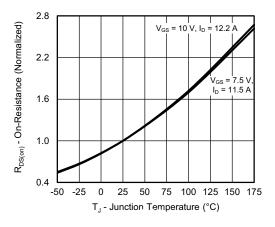
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



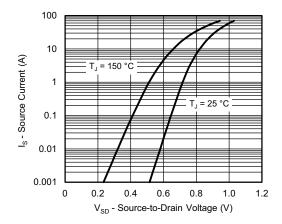
**Gate Charge** 



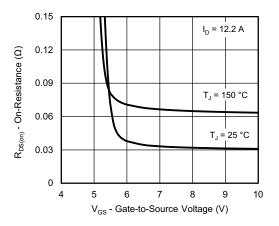
On-Resistance vs. Junction Temperature

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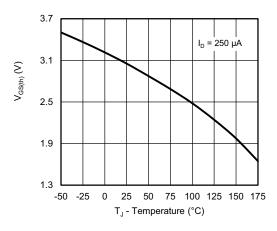
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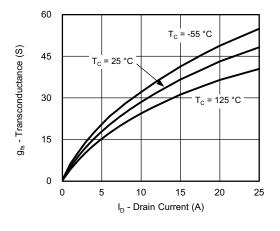
Source-Drain Diode Forward Voltage



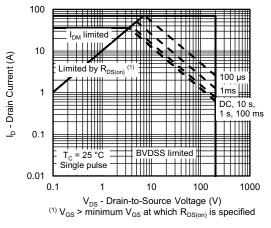
On-Resistance vs. Gate-to-Source Voltage



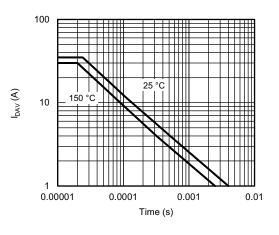
**Threshold Voltage** 



Transconductance



Safe Operating Area, Junction-to-Ambient



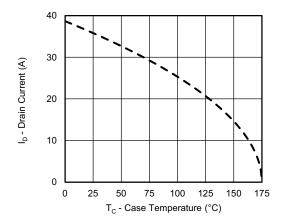
Avalanche vs. Time

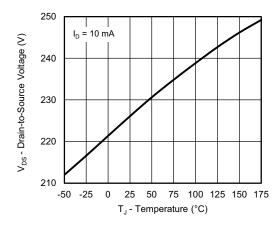


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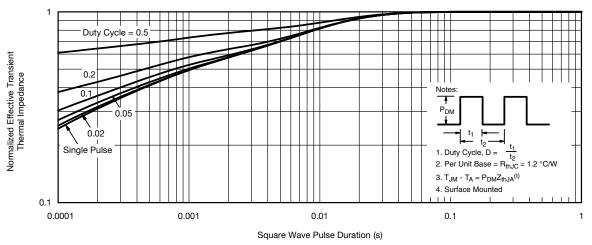


Current Derating a

Drain Source Breakdown vs. Junction Temperature

#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



Normalized Thermal Transient Impedance, Junction-to-Case

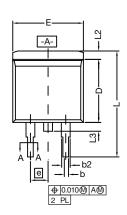
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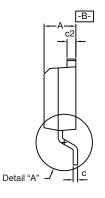
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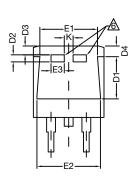


# TO-263 (D<sup>2</sup>PAK): 3-LEAD

### **VERSION 1: FACILITY CODE = T**

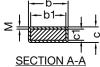








**DETAIL A (ROTATED 90°)** 



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< T		10	ပ
SF	CTION	1	1

## **Notes**

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. \*: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6. This feature is for thick lead.

		INC	HES	MILLIMETERS		
	DIM.	MIN. MAX.		MIN.	MAX.	
Α		0.160	0.190	4.064	4.826	
	b	0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
c*	Thin lead	0.013	0.018	0.330	0.457	
١	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
Ü	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
	D2	0.038	0.042	0.965	1.067	
	D3	0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	E	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
	E2	0.355	0.375	9.017	9.525	
	E3	0.072	0.078	1.829	1.981	
	е	0.100	BSC	2.54	BSC	
	K	0.045 0.055 1.143 1		1.397		
L		0.575	0.625	14.605	15.875	
	L1	0.090	0.110	2.286	2.794	
	L2	0.040	0.055	1.016	1.397	
	L3	0.050	0.070	1.270	1.778	
	L4	0.010	BSC	0.254	BSC	
	М	-	0.002	-	0.050	

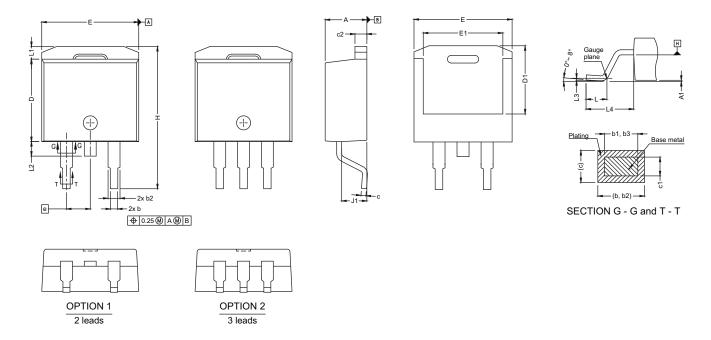
Revison: 28-Oct-2024 Document Number: 71198



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## **VERSION 2: FACILITY CODE = N**



DIM.	MIN.	MAX.
A	4.36	4.56
A1	0	0.25
b	0.70	0.90
b1	0.51	0.89
b2	1.20	1.46
b3	1.17	1.37
С	0.38	0.694
c1	0.38	0.534
c2	1.19	1.34
D	8.60	9.00
D1	6.9	7.5
E	10.15	10.55
E1	8.1	8.7
е	2.54	BSC
Н	15.0	15.6
L	1.9	2.5
L1	-	1.65
L2	-	1.78
L3	0.25	5 typ.
L4	4.78	5.28
J1	2.56	2.96

DWG: 5843





## RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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